

**Lecture 20: Interconnects**

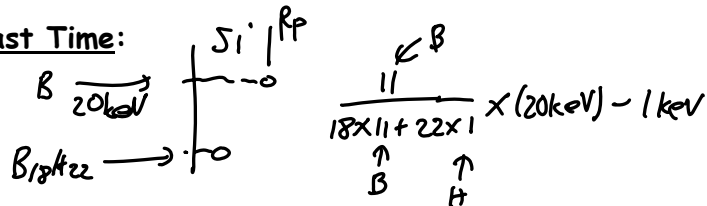
**Announcements:**

- Lab 1 Report will be due Friday, April 23
  - ↳ Instructions for the report will online on the EE143 Lab link
  - ↳ You can (and should) start on it now!

**Lecture Topics:**

- ↳ **Advanced Diffusion**
  - Effect of E-Field on Diffusion
  - Concentration-Dependent Diffusion
- ↳ **Interconnects & Contacts**
  - Planar Process Compatible Metals
  - Ohmic vs. Diode Contacts
  - Sintering
  - Measuring Contact Resistance
  - Electromigration
  - Space-Saving Contact Strategies
  - Silicidation
  - Lift-Off
  - Multilevel Metallization
    - Damascene Process
- ↳ **Metal MEMS Surface-Micromachining**

**Last Time:**



- How does one measure the resistance from one point to another accurately?

**Problem: What about:**

- ① the resistance in the leads?
- ② the contact resistance (which can be high)?

↳ How can you tell your film's resistance vs. these?

**Soln: 4 pt. probe**

**Divide into Squares -> get sheet resistance**

**high resistance (no current flow into these leads)**

↳ Get the R between the two inner probes, and only the inner probes (even contact R nulled out)

$R = \frac{V}{I}$

4-pt. Probe Over a Wafer

Current now distributed.  
 $\Rightarrow$  resistivity expression:  
 $\rho = 2\pi s \left(\frac{V}{I}\right) \Omega \cdot m \quad \text{for } t \gg s$   
 $\rho = \left(\frac{\pi t}{\ln 2}\right) \cdot \left(\frac{V}{I}\right) \Omega \cdot m \quad \text{for } t \ll s$

$\rightarrow$  This is the more relevant case:

$R_s = \frac{\rho}{t} = \left(\frac{\pi}{\ln 2}\right) \cdot \left(\frac{V}{I}\right) \Omega / \square = 4.53 \frac{V}{I} \Omega / \square \quad (t \ll s)$

2nd Order Diffusion Effects

Effect of Electric Field on Diffusion

① donor  $\rightarrow$  releases an  $e^-$  that can diffuse faster than the As atom itself  
 $\hookrightarrow e^-$ 's have higher mobility than atoms

②  $e^-$  front gets ahead of the diffusing As front

Concentration vs Depth

$As^+$

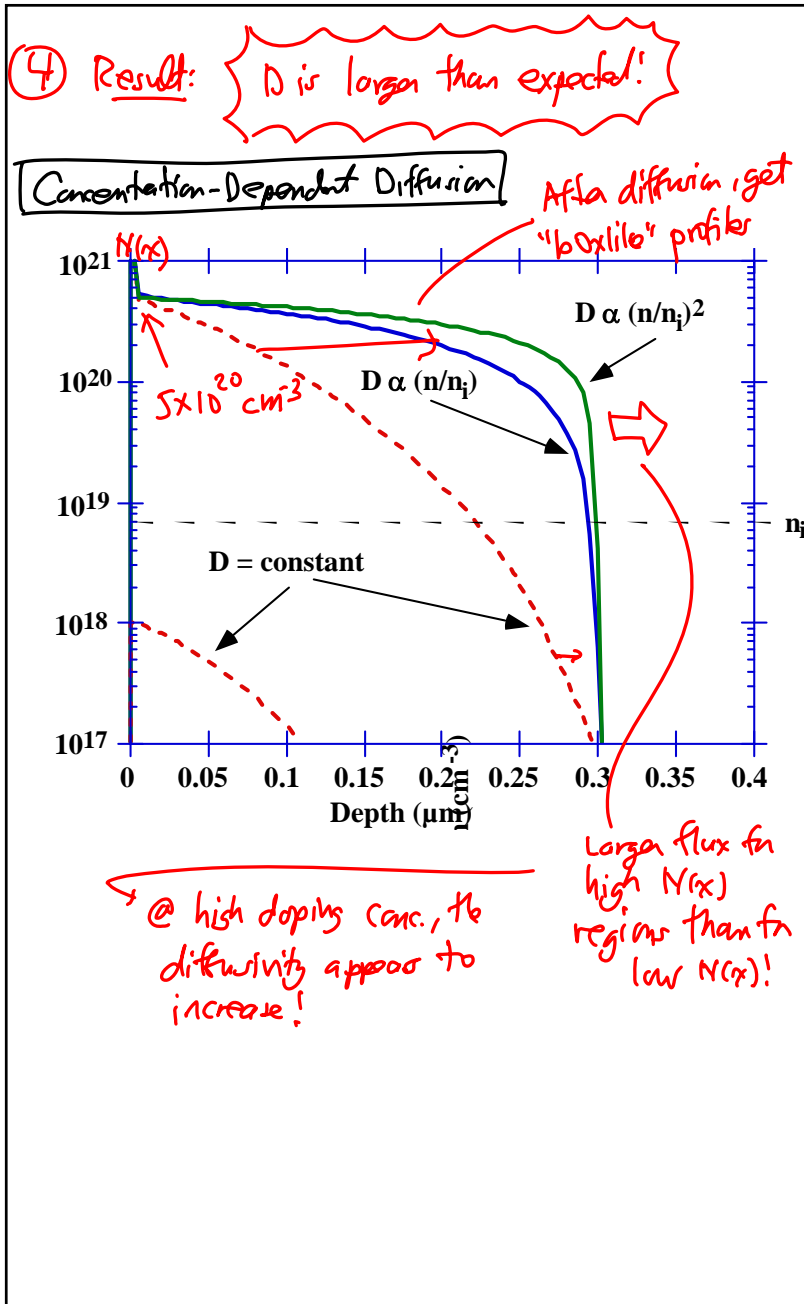
$e^-$

$\epsilon$ -field

Pictorially: (for n-type)

ions pulled to the right faster than normal due to the  $\epsilon$ -field

③  $\epsilon$ -field also slows the  $e^-$ 's down  $\hookrightarrow$  achieve equilibrium



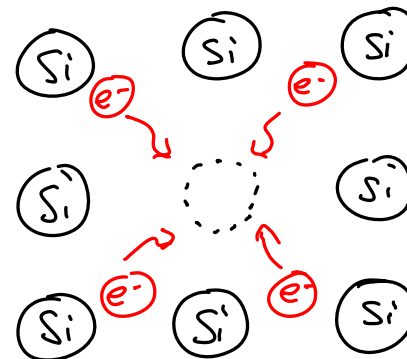
- Why is this happening?
  - ↳ Since diffusion involves both the dopant and a vacancy that it can move into, it can be modeled as the movement of a dopant-vacancy pair
  - ↳ The rate of diffusion depends upon the charge state of the vacancy

Possible Diffusion Species	$I-V^0$	$I-V^+$	$I-V^-$	$I-V^{2-}$	$I-V^{3-}$
Diffusion Const.	$D^0$	$D^+$	$D^-$	$D^{2-}$	$D^{3-}$

Where  $I-V^x \leftarrow$  charge state of the vacancy

$\uparrow$  impurity atom

$\uparrow$  vacancy



- ① When doping level is high  $\rightarrow$  lots of  $e^-$ 's.
- ② Vacancies can soak up  $e^-$ 's  $\therefore$  get a charge
- ③ Get "charged vacancy"  $\rightarrow$  get more of them when doping level is high!

The net diffusion is the sum of the various components:

↳ D can be well described by:

$$D_A^{\text{eff}} (\text{n-type}) = D^0 + D^- \left(\frac{n}{n_i}\right) + D^+ \left(\frac{n}{n_i}\right)^2$$

↑  
diffusivity of  
a dopant-neutral  
point-defect pair

↑ intrinsic  
conc.  
↑  
diffusivity of charged  
point-defect pairs